## Electronics for GLD Calorimeter

#### 2005/08/24 GLD CAL session at Snowmass H. Matsunaga

## **Photon Sensors**

- Photon sensors
  - Hamamatsu MPC (Multi-pixel photon counter)
  - Russian SiPM
  - Directly attached to the scintillator end
- Common for ECAL, HCAL and muon detector
  - Huge number of channels:
    - ECAL: ~6M
    - HCAL: ~30M
    - (muon: ~10k)



 $\Rightarrow 1 \text{ mm}$   $\Rightarrow 1 \text{ mm}$   $\Rightarrow 1 \text{ mm}$   $\Rightarrow 1 \text{ mm}$ 

≒1mm

#### Some issues on sensors

- Operational voltage range is narrow
  - ~0.1 V for MPC
    - Accurate bias voltage control (and also modest temperature control) is necessary
    - Power supply is also the key issue
- Probably, operational voltage of MPC varies from device to device
  - How to know the best voltage for huge number of devices ?
  - How to provide various bias voltages to them ?

## Requirement for FE Readout

- Number of pixels: ~1000 -> 10~12 bit dynamic range
- Good timing resolution
  - Bunch ID
  - Slow neutron detection?
  - TOF at the innermost layer of ECAL ?
- Dark hit-rate: < 1MHz tolerable ?
- Low power consumption:
  - ~20mW/ch may be possible
  - Power loss in cable should be small

## Requirement (cont)

- Readout between bunch trains (200ms)
  - Assuming 1Gbit/sec transfer rate,
    - ~25 Mbytes at maximum
    - 4 bytes/event x ~6k events/trains is possible
  - Zero suppression
  - Buffers



## Solution by CALICE group

- Talk by Felix Sefkow (DESY) in Calorimeter session
- This is just for testbeam; may need better method for production
  - Number of sensors: a few thousands
  - SiPMs with ~1000 pixels
  - During testbeam, they will be monitoring sensor gain with LED, without temperature control



## Bias voltage adjustment

- Bias voltages are determined at test bench in advance for all sensors
  - 15 SiPMs under monitored LED source
  - Adjust working point (bias voltage) to 15 pixels/MIP
  - Up to 500 / week







## Voltage variation

- Two clusters for bias voltage setting:
  - 33~41V, 60~67V
- Sensors are grouped in modules according to bias voltage
  - 108 / half module
  - +- 2V / module



## **Front-end Electronics**

- ILC-SiPM chip: 18ch Pre-amplifier, shaper, track and hold, mux
  - based on CALICE
    SiW ECAL chip



# Our plan

- ECAL beamtest: ~2007 (FNAL / DESY) ?
  - Front-end electronics and DAQ
    - DAQ system might be shared with other groups?
  - Mass production and quality control
- Beyond testbeam
  - -???
- Manpower:
  - Manobu Tanaka (KEK) : ASIC development
  - Patrick LeDu is interested ...
  - Others?

## Basic idea of FE board

 SQV: Synchronous Current Integrator for Q-to-V conversion



## SQV-TEG & Ethernet board

- Prototype boards already exist
- Bias voltage controller should be added





## Backup

## Some comments on DAQ

- In my opinion, there is no big difference between three concepts
  - No need for hardware trigger; Only software trigger (running on commodity PCs) may be sufficient
  - Number of channels are quite large compared to previous experiments
  - New technology should be followed up
  - GDN, Grid?
- In order to establish the DAQ scheme, communication with sub-detector groups is necessary
  - Cost estimatation
- Patrick will talk more details about (his) current idea